



## **LG Electronics, Intel Collaborate on Future Mobile Internet Devices**

### **LG's Focus on Data and Voice Devices Complements Existing Strong Relationship around Notebooks and Netbooks**

MOBILE WORLD CONGRESS, Barcelona, Spain - Feb. 16, 2009 - LG Electronics (LG) and Intel Corporation today announced a collaboration around mobile Internet devices (MIDs) based on Intel's next-generation MID hardware platform, codenamed "Moorestown," and Linux-based Moblin v2.0 software platform. The LG device is expected to be one of the first Moorestown designs to market.

LG and Intel's common goal is to unleash rich Internet experiences across a range of mobile devices while delivering the functionality of today's high-end smart phones. The collaboration on the new design extends a close working relationship the two companies have enjoyed across their respective mobile product lines, which now spans the notebook, netbook and MID categories.

"The MID segment will drive growth at LG Electronics. We chose Intel's next-generation Moorestown platform and Moblin-based OS to pursue this segment because of the high performance and Internet compatibility this brings to our service provider customers," said Jung Jun Lee, executive vice president of LG Electronics and head of its Mobile Communications Business Division. "The collaboration with Intel on the MID platform has been valuable and further extends our longstanding relationship. Our efforts are well on track and we look forward to bringing the MID to market."

LG launched a netbook, based on the Intel® Atom™ processor, in the fourth quarter of 2008, and has been supplying the mobile companion device to carriers and retailers worldwide. LG also continues to ship notebooks based on the Intel® Core™ processor.

MIDs represent an emerging growth category in the industry and are designed to bring a rich, interactive, PC-like Internet experience in pocketable devices. The experience on a MID will help usher in the many new Internet trends performed predominantly on a PC to mobile devices.

"Moorestown" is the codename for Intel's second-generation MID platform, which consists of a System on Chip (codenamed "Lincroft") that integrates a 45nm Intel® Atom™ processor core, graphics, video and memory controller. The platform also includes an input/output (I/O) hub, codenamed "Langwell," that includes a range of I/O blocks and supports wireless solutions.

Intel's "Moorestown"-based MIDs are expected to reduce idle power consumption by a factor of greater than 10 versus today's Intel Atom processor-based MIDs. Additionally, the Moorestown platform will be accompanied by a newer Moblin software version, Moblin v2.0, that is based on the Linux operating system. This software is designed specifically to deliver a great PC-like Internet experience while also supporting cell phone voice capabilities. The "Moorestown" platform is expected to come to market by 2010.

"LG Electronics makes some of the most innovative computers and smart phones in the world, and is known to be a leading-edge player in every market segment they serve," said Anand Chandrasekher, Intel Corporation senior vice president and general manager of the company's Ultra Mobility Group. "We look forward to providing them some fantastic Intel products that will deliver the best Internet experience while dramatically reducing power -contributing to the development of ultra sleek devices that offer superb battery life."

In order to offer a variety of network connections and Internet access, LG is also working with Ericsson to bring 3G network capability to its planned MID. This is an extension of the existing collaboration between the companies. LG has been supplying notebooks and netbooks with mobile broadband modules from Ericsson since the third quarter of 2008.

"We are glad that LG Electronics has chosen Ericsson to provide 3G capabilities in its Intel-based MID. We are working with LG and Intel to deliver industry-leading 3G capabilities on the Moorestown MID," said Mats Norin, vice president and head of Ericsson Mobile Broadband Modules. "Ericsson's unparalleled relationships with global service providers will be instrumental as we define plans with LG to take this MID to market across multiple geographies around the world."

#### **About Intel**

Intel (NASDAQ: INTC), the world leader in silicon innovation, develops technologies, products and initiatives to continually

advance how people work and live. Additional information about Intel is available at [www.intel.com/pressroom](http://www.intel.com/pressroom) and [blogs.intel.com](http://blogs.intel.com).

**About LG Electronics, Inc.**

LG Electronics, Inc. (KSE: 066570.KS) is a global leader and technology innovator in consumer electronics, home appliances and mobile communications, employing more than 82,000 people working in 114 operations including 82 subsidiaries around the world. With 2008 global sales of USD 44.7 billion, LG is comprised of five business units - Home Entertainment, Home Appliance, Air Conditioning, Business Solutions and Mobile Communications. LG is the world's leading producer of mobile handsets, flat panel TVs, air conditioners, front-loading washing machines, optical storage products, DVD players and home theater systems.

LG Electronics Mobile Communications Company (LG) is a leading global mobile communication and information company. LG creates handsets that provide an optimized mobile experience to customers around the world with its cutting-edge technology and innovative handset design capabilities. Increasingly, LG is pursuing convergence technology and mobile computing products. LG will continue to take leadership in the mobile communication environment with stylish designs and smart technology. For more information, please visit [www.lge.com](http://www.lge.com).

For more information on Mobile World Congress, visit the press kit at [www.intel.com/pressroom/kits/events/mobileworld2009](http://www.intel.com/pressroom/kits/events/mobileworld2009)

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